

January 2011

# MMSD3070 Small Signal Diode



SOD123 COLOR BAND DENOTES CATHODE TOP MARKING: 33

# **Absolute Maximum Ratings \*** $T_a = 25$ °C unless otherwise noted

Symbol	Parameter	Value	Units
$V_{RRM}$	Maximum Repetitive Reverse Voltage 200		V
I <sub>F(AV)</sub>	Average Rectified Forward Current	200	mA
I <sub>FSM</sub>	Non-repetitive Peak Forward Surge Current Pulse Width = 1.0 second Pulse Width = 1.0 microsecond	1.0 2.0	A A
T <sub>STG</sub>	Storage Temperature Range	-55 to +150	°C
T <sub>J</sub>	Operating Junction Temperature	150	°C

<sup>\*</sup> These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

## **Thermal Characteristics**

Symbol	Parameter	Value	Units
P <sub>D</sub>	Power Dissipation	400	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	312	°C/W

## **Electrical Characteristics** $T_a = 25$ °C unless otherwise noted

Symbol	Parameter	Conditions	Min.	Max.	Units
V <sub>R</sub>	Breakdown Voltage	I <sub>R</sub> = 100μA	200		V
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 100mA		1.0	V
I <sub>R</sub>	Reverse Leakage	V <sub>R</sub> = 175V V <sub>R</sub> = 175V, T <sub>A</sub> = 150°C		100 100	nA μA
C <sub>T</sub>	Total Capacitance	$V_R = 0, f = 1.0MHz$		5.0	pF
t <sub>rr</sub>	Reverse Recovery Time	$I_F = I_R = 30 \text{mA},$ $I_{RR} = 1.0 \text{mA}, R_L = 100 \Omega$		50	ns

# **Typical Performance Characteristics**

Figure 1. Forward Voltage vs Forward Current

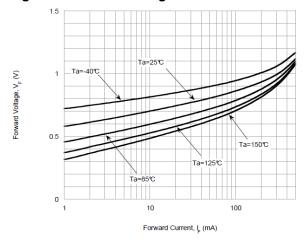


Figure 2. Reverse Current vs Reverse Voltage

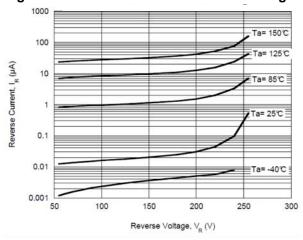
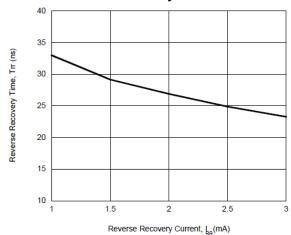


Figure 3. Reverse Recovery Time vs Reverse Recovery Current







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Definition of Terms				
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